

**TOSHIBA**

**2:1 Mux/1:2 De-Mux  
TDS4A212MX  
Evaluation Board  
Through Path Board  
User's Guide**

2024-07-16

# 2:1 Mux/1:2 De-Mux TDS4A212MX General

## ➤ General

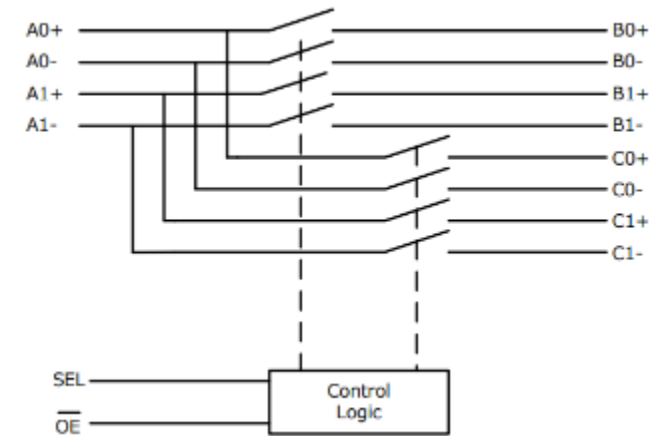
- 1-32Gbps 1-Lane Tow Differential Channel, 2:1 Mux/1:2 De-Mux
- This Switch can be used for high-speed differential interface such as PCIe®5.0, USB4®Version2, Thunderbolt™4, DisplayPort™.

## ➤ High frequency characteristics ( $V_{CC} = 1.6 \sim 3.6 \text{ V}$ )

Item	Symbol	Condition	Typ.	Unit
-3dB Bandwidth	BW	$R_T = 50\Omega$	<b>26.2</b>	GHz
Insertion loss	DDIL	$f=10 \text{ GHz}$ $R_L = 50\Omega$	<b>-1.1</b>	dB
Return loss	DDRL	$f=10 \text{ GHz}$ $R_L = 50\Omega$	<b>-17</b>	dB
OFF isolation	DDOIRR	$f=10 \text{ GHz}$ $R_L = 50\Omega$	<b>-17</b>	dB
Crosstalk	DDXT	$f=10 \text{ GHz}$ $R_L = 50\Omega$	-32	dB

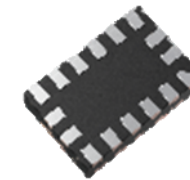
These items can be evaluated on this board.

## ➤ Block Diagram

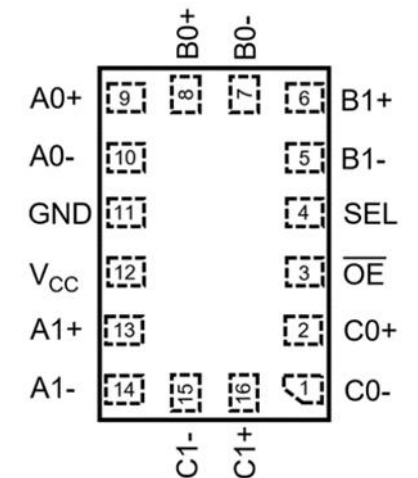


## ➤ Package

XQFN 1.6×2.4 mm

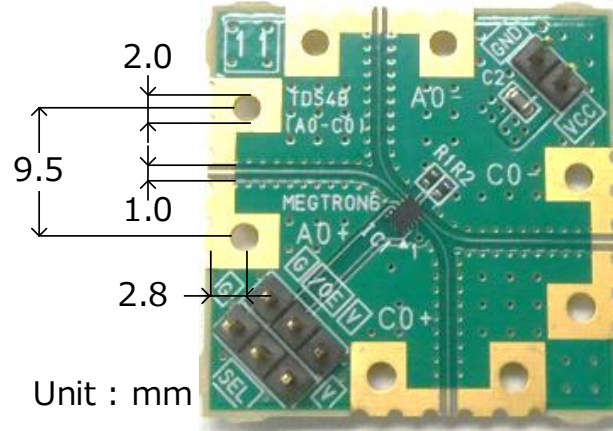


## ➤ Pin assignment



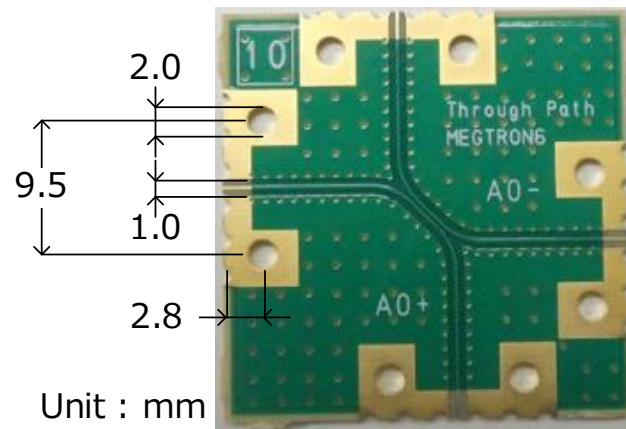
# TDS4A212MX Evaluation board Basic information

- This board can measure  $A0+ \leftrightarrow C0+$  path,  $A0- \leftrightarrow C0-$  path.
- The differential line on this board is minimized to measure RF signals, but the measurement results include the influence of the board.  
Therefore, a through-path board should be used to remove the board's influence from the measurement results. (See P.5)



## ➤ TDS4A212MX Evaluation board\* (See P.3 P.4)

- Size : 31.11 × 28.87 mm\*\*
- Material : MEGTRON6(Materials for high-frequency signal transmission)
- Evaluated path :  $A0+ \leftrightarrow C0+$  path,  $A0- \leftrightarrow C0-$  path
- Evaluated Characteristics : Insetion loss (-3db Bandwidth) , Return loss, OFF isolation



## ➤ Through Path Board (See P.5)

- Size : 28.97 × 28.97 mm\*\*
- Material : MEGTRON6(Materials for high-frequency signal transmission)

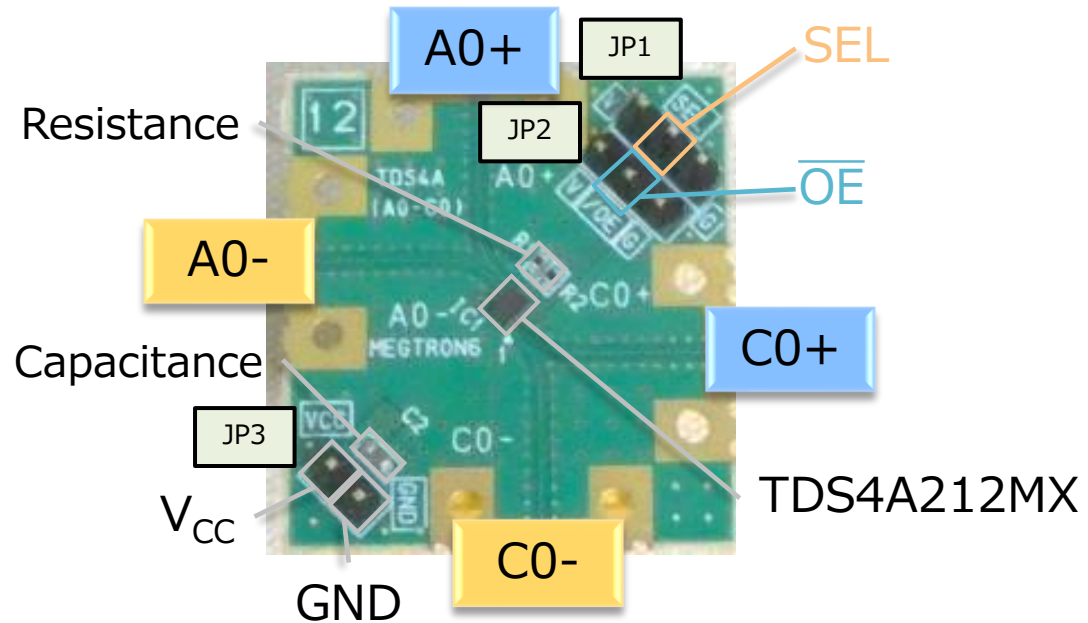
\*Mounted components are already mounted, but the high-frequency connectors for measurement are not installed.(See P.6)

\*\*Size TDS4A212MX Evaluation board and Through Path Board are different to align the length of line including chip .

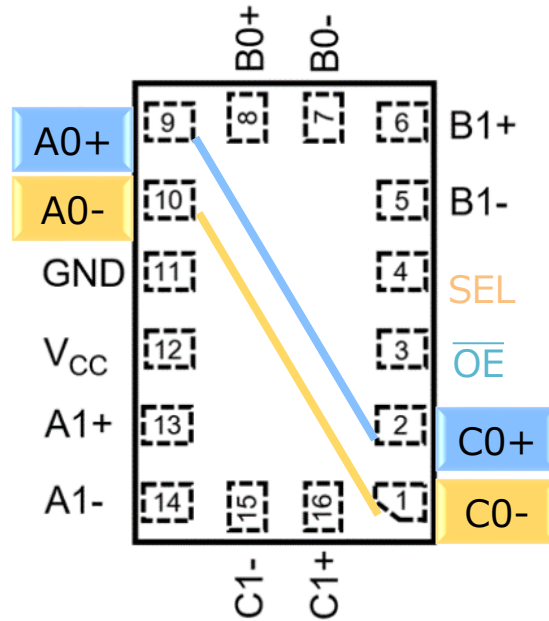
# TDS4A212MX Evaluation board General

- This board can measure  $A0+ \leftrightarrow C0+$ ,  $A0- \leftrightarrow C0-$  as a representative path.

## ➤ Board Top View



## ➤ TDS4A212MX Top View



## ➤ Pin Connections

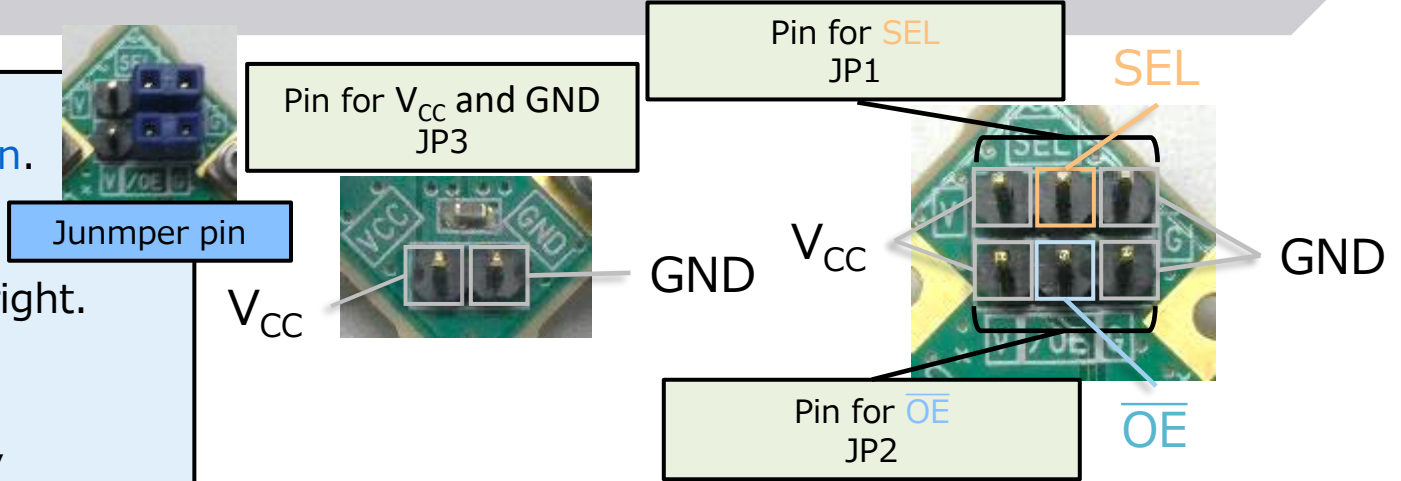
TDS4A212MX		Board
Pin No.	Pin Name	Connection
1	C0-	Connector
2	C0+	Connector
3	OE	JP2
4	SEL	JP1
5	B1-	OPEN
6	B1+	OPEN
7	B0-	50Ω
8	B0+	50Ω
9	A0+	Connector
10	A0-	Connector
11	GND	GND
12	V <sub>CC</sub>	JP3
13	A1+	OPEN
14	A1-	OPEN
15	C1-	OPEN
16	C1+	OPEN

✓ Instructions for use are explained on the next page.

# TDS4A212MX Evaluation board Instructions for use

- Measure with a network analyzer.
- Connect control input to H or L with a **jumper pin**.
- Supply  $V_{CC}$  after control input is connected.
- Supply  $V_{CC}$  and GND from JP3.
- For connections, refer to the truth table on the right.

- ① Measure insertion loss (-3db Bandwidth)**  
 With  $\overline{OE}$  connected to GND and the switch active, connect **SEL** to  $V_{CC}$  and  $A \Leftrightarrow C$  path.  
 →You can measurement insertion loss from the signal power.
- ② Measure return loss**  
 The port connection method is the same as ①.  
 →You can measure return loss from return power.
- ③ Measure OFF isolation**  
 With  $\overline{OE}$  connected to GND and the switch active, connect **SEL** to GND and disconnect  $A \Leftrightarrow C$  path.  
 →You can measurement OFF isolation from the signal power.
- ④ Disconnect the switch**  
 Connect  $\overline{OE}$  to  $V_{CC}$ , the switch is disconnected.  
 →the ports are disconnected.



➤ **Truth table** H :  $V_{CC}$ , L : GND, X : Don't Care

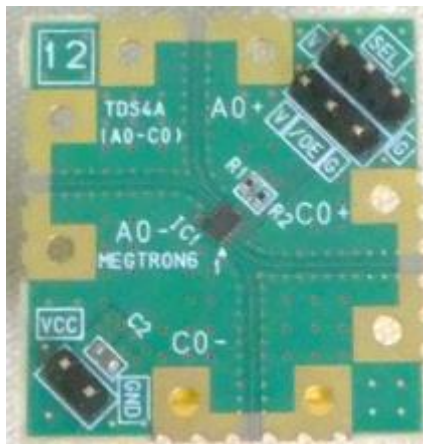
Item	Control Input $\overline{OE}$	Control Input <b>SEL</b>	Function	View
① ②	L	H	An+ Port = Cn+ Port An- Port = Cn- Port	
③	L	L	An+ Port = Bn+ Port An- Port = Bn- Port	
④	H	X (Connect to H or L)	Disconnect	

# Through Path Board Instructions for use

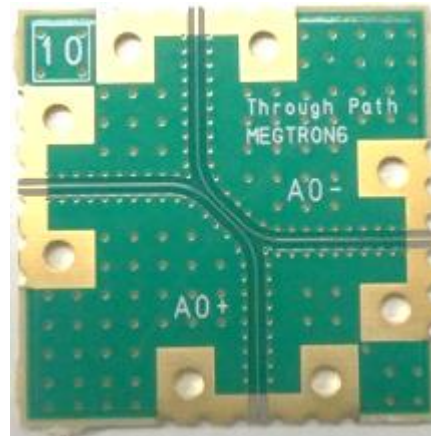
## ➤ Through Path Board General

- The TDS4A212MX evaluation board measurement results include the influence of the board.  
→ Measure only evaluation board to remove the influence of the board.
- Measure Through Path Board.
- As shown in the image below, subtract the Through Path Board measurement results from the TDS4A212MX evaluation board measurement results to get TDS4A212MX measurement results.

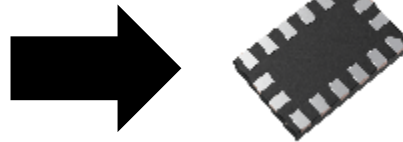
## ➤ Image of measure



TDS4A212MX  
Evaluation board  
measurement results

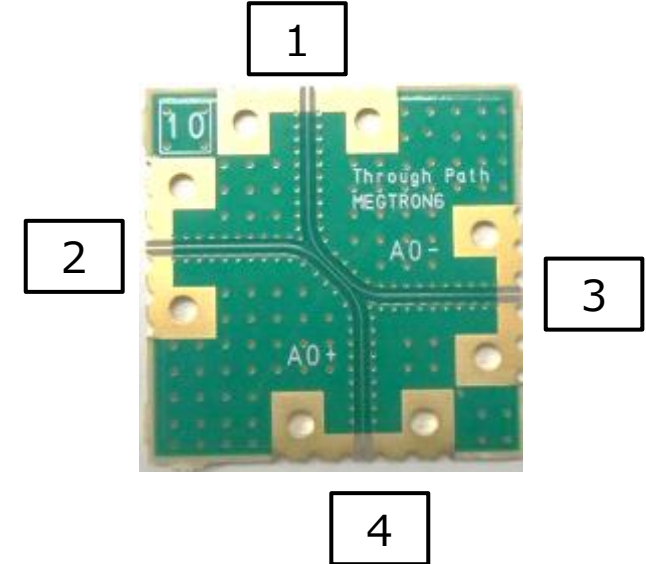


Through Path Board  
measurement  
results

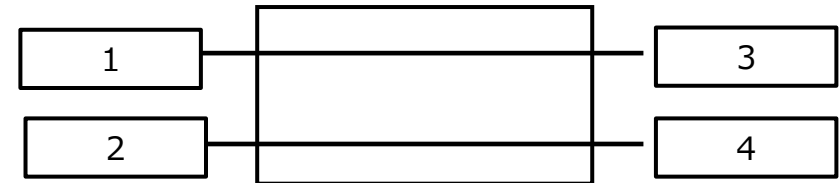


TDS4A212MX  
Measurement  
results

## ➤ Board Top View



## ➤ Board circuit



# Connector we recommend(End launch connector)

## ➤ End launch connector Genral

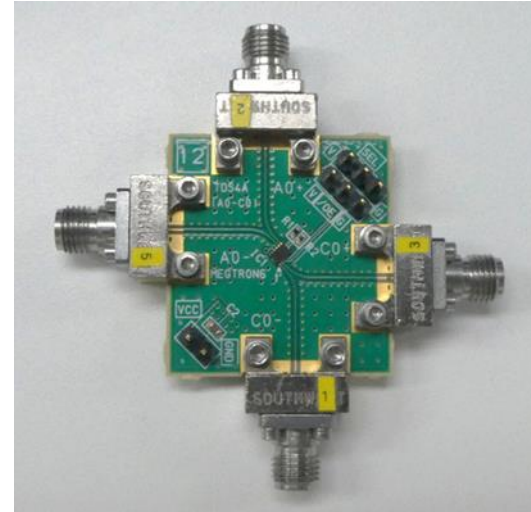
Model : 1092-04A-6

Manufacturer : Southwest Microwave

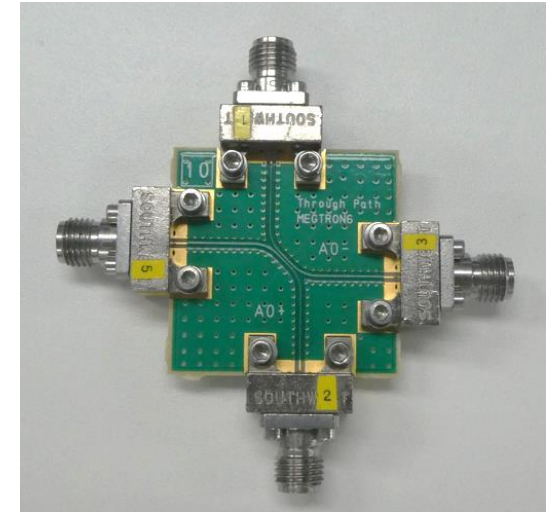
Frequency : 18, 27, 36, 40 GHz

Style : 2.92mm End Launch (K)

## ➤ Image



TDS4A212MX  
Evaluation board



Through Path Board

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